

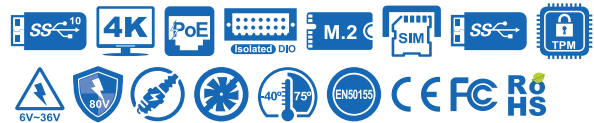
ECX-1411/1311

8th Generation Intel® Xeon®/Core™ i7/i5/i3 (Coffee Lake) Expandable Fanless System with Intel® C246 Chipset, 6 GigE LAN with 4 PoE+, 4 Front-access SSD Tray, 1 PCIe x16, 1 PCI, 6 USB 3.1, 2 M.2 Socket, 3 SIM, 32 Isolated DIO, High Performance, Rugged, -40°C to 75°C Extended Temperature



Features

- 6 Cores 8th Generation Intel® Xeon®/Core™ i7/i5/i3 (Coffee Lake-S) with workstation-grade Intel® C246 Chipset
- Fanless, -40°C to 75°C Operating Temperature
- 6 Independent GigE LAN with 4 IEEE 802.3at PoE+
- 32 Isolated DIO, 6 USB 3.1, 4 COM RS-232/422/485
- Storage : 4 2.5" SSD Tray, 1 CFast, 1 M.2, 4 SATA III
- Expansion : 1 PCIe x16, 1 PCI, 2 Mini PCIe/mSATA, 1 M.2
- PCIe x16 expansion supports up to 200W Power Budget
- Display : VGA, DVI-D & 2 DisplayPort interfaces, up to 4K resolution
- 3 External SIM Socket for WiFi/4G/3G/LTE/GPRS/UMTS
- 6V to 36V DC Power Input with 80V Surge Protection
- Configurable Ignition Power Control



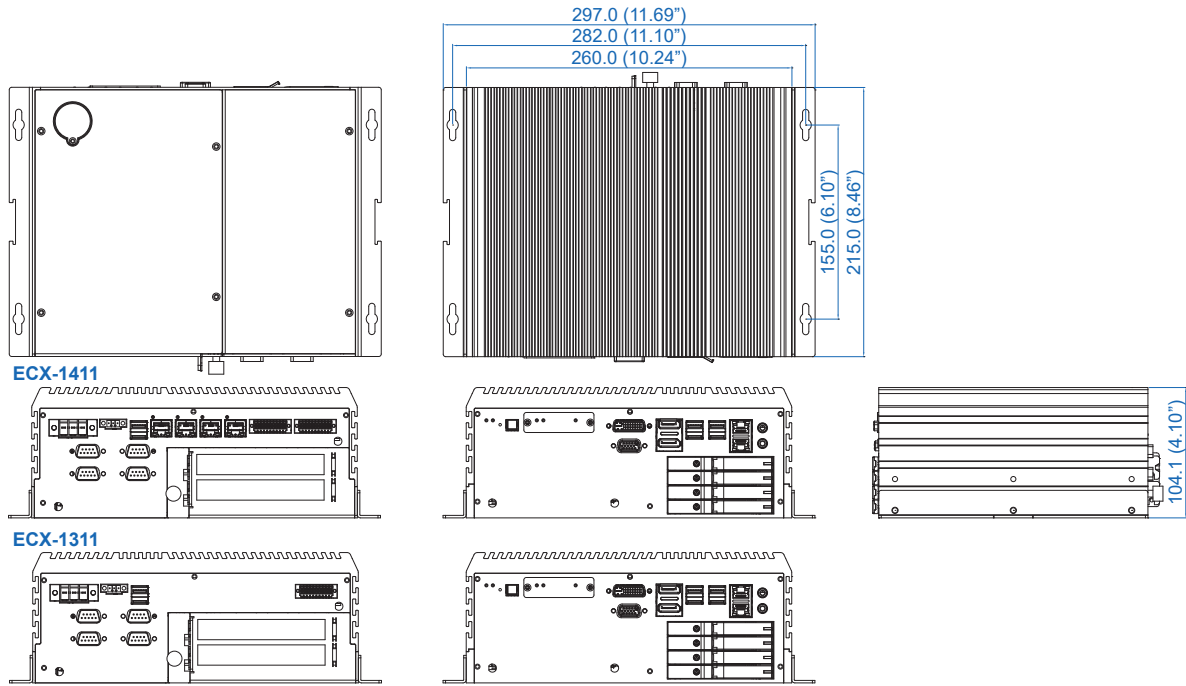
Specifications

System	
Processor	Intel® Xeon®/Core™ i7/i5/i3 Processor (Coffee Lake-S)
Chipset	Intel® C246
BIOS	AMI
SIO	IT8786E
Memory	2 DDR4 2666MHz SO-DIMM, up to 32GB
I/O Interface	
Serial	4 COM RS-232/422/485 (ESD 8KV)
USB	▪ 6 USB 3.1 (6 External) ▪ 1 USB 2.0 (Internal)
Isolated DIO	ECX-1411 : 32 Isolated DIO : 16 DI, 16 DO ECX-1311 : 16 GPIO
LED	Power, HDD, Wireless, PoE (ECX-1400)
SIM Card	3 External SIM Card Socket
Expansion	
Mini PCIe	2 Full-size for PCIe/USB/External SIM Card/mSATA
PCIe	1 PCIe x16
PCI	1 PCI
M.2	1 M.2 Key E Socket
SUMIT A, B	2 SUMIT Slot (Optional)
Graphics	
Graphics Processor	Intel® UHD Graphics P630/630
Interface	▪ 1 VGA : Up to 1920 x 1200 @ 60Hz ▪ 1 DVI-D : Up to 1920 x 1200 @ 60Hz ▪ 2 DisplayPort : Up to 4096 x 2304 @ 60Hz
Storage	
SATA	4 SATA III (6Gbps) support S/W RAID 0, 1, 5, 10
mSATA	2 SATA III (Mini PCIe Type, 6Gbps)
M.2	1 M.2 Key B Socket
Storage Device	▪ 1 CFast Socket, Push-in/Push-out Ejector ▪ 4 Front-access 2.5" SSD/HDD Tray
Audio	
Audio Codec	Realtek ALC892, 5.1 Channel HD Audio
Audio Interface	1 Mic-in, 1 Line-out
Ethernet	
LAN 1	Intel® I219LM GigE LAN supports iAMT 12.0
LAN 2	Intel® I210 GigE LAN

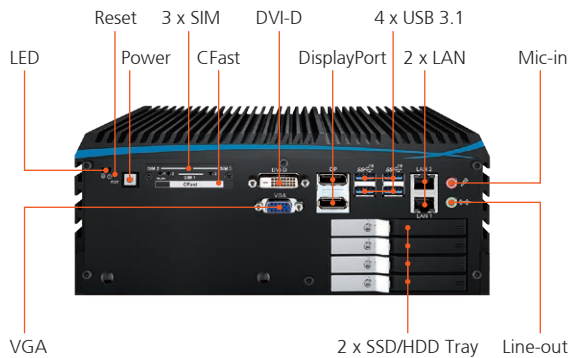
PoE (ECX-1400)	
LAN 3 to 6	GigE IEEE 802.3at (25.5W/48V) PoE+ by Intel® I210
Power	
Power Input	6V to 36V, DC-in
Power Interface	3-pin Terminal Block : V+, V-, Frame Ground
Ignition Control	16 Mode (Internal)
Remote Switch	3-pin terminal block : On, Off, IGN
Surge Protection	Up to 80V/1ms Transient Power
Others	
TPM	Optional Infineon SLB9665 supports TPM 2.0, LPC Interface
Watchdog Timer	Reset : 1 to 255 sec./min. per step
Smart Management	Wake on LAN, PXE supported
HW Monitor	Monitoring temperature, voltages. Auto throttling control when CPU overheats.
Software Support	
OS	Windows 10, Linux
Mechanical	
Dimensions (W x L x H)	260mm x 215mm x 104.1mm (10.2" x 8.46" x 4.0")
Weight	5.5 kg (12.13 lb)
Mounting	▪ Wallmount by mounting bracket ▪ DIN Rail Mount (Optional)
Environment	
Operating Temperature	35W TDP CPU : -40°C to 75°C (-40°F to 167°F) 65W TDP CPU : -40°C to 55°C (-40°F to 131°F) 80W TDP CPU : -40°C to 45°C (-40°F to 113°F)
Storage Temperature	-40°C to 85°C (-40°F to 185°F)
Humidity	5% to 95% Humidity, non-condensing
Relative Humidity	95% @ 75°C
Shock	▪ IEC 60068-2-27 ▪ SSD : 50G @ wallmount, Half-sine, 11ms
Vibration	▪ IEC 60068-2-64 ▪ SSD : 5Grms, 5Hz to 500Hz, 3 Axis
EMC	CE, FCC, EN50155, EN50121-3-2

Dimensions

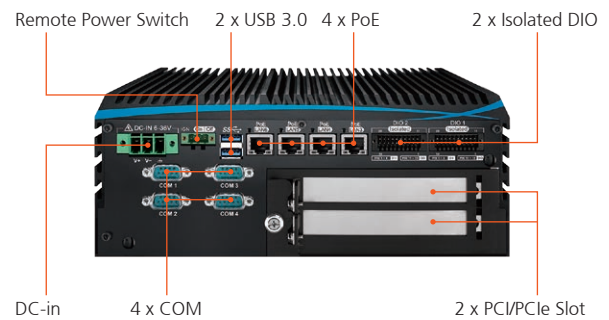
Unit : mm/ inch



Front I/O



Rear I/O



Order Information

ECX-1411	ECX-1400, 6 GigE LAN w/4 PoE+, 4 SSD Tray, 1 PCIe x16, 1 PCI, 6 USB 3.1, 4 COM, 3 SIM, 32 Isolated DIO
ECX-1311	ECX-1300, 2 GigE LAN, 4 SSD Tray, 1 PCIe x16, 1 PCI, 6 USB 3.1, 4 COM, 3 SIM, 16 GPIO

Accessories

DDR4 16G	Certified DDR4 16GB 2666MHz RAM
DDR4 8G	Certified DDR4 8GB 2666MHz RAM
DDR4 4G	Certified DDR4 4GB 2666MHz RAM
PWA-160W-WT	160W, 24V, 85V AC to 264V AC Power Adapter with 3-pin Terminal Block, Wide Temperature -30°C to +70°C
PWA-280W-WT	280W, 24V, 85V AC to 264V AC Power Adapter with 3-pin Terminal Block, Wide Temperature -30°C to +70°C
VESA Mount	VESA Mounting Kit
DIN-RAIL	DIN Rail Kit
TMK2-20P-100	Terminal Block 20-pin to Terminal Block 20-pin Cable, 100cm
TMK2-20P-500	Terminal Block 20-pin to Terminal Block 20-pin Cable, 500cm
TMB-TMBK-20P	Terminal Board with One 20-pin Terminal Block Connector and DIN-Rail Mounting
4G Module	Mini PCIe 4G/GPS Module with Antenna
WiFi & Bluetooth	WiFi & Bluetooth Module with Antenna

CPU List

Series	CPU	Cache (MB)	Turbo Freq. (GHz)	TDP (W)	ECC Memory
Intel® Xeon®	E-2176G	12	4.6	80	Yes
	E-2124G	8	4.5	71	
Intel® Core™	i7-8700	12	4.6	65	NA
	i7-8700T	12	4.0	35	
	i5-8500	9	4.1	65	NA
	i5-8500T	9	3.5	35	
	i3-8100	6	3.6	65	Yes
	i3-8100T	6	3.1	35	